

T-25-15

Power triac suited for use on 200 V and 380 V main.

FEATURES :

- Glass passivated chip.
- IGT specified in four quadrants.

ADVANTAGES :

- Excellent $(dv/dt)_C > 10 \text{ V}/\mu\text{s}$.
- Metallic encapsulation gives an excellent thermal impedance and high reliability construction.

APPLICATIONS :

- Motor control.
- Heating control.
- Light dimmer.

Triac de puissance utilisable sur les réseaux 200 V et 380 V.

CARACTERISTIQUES :

- Pastille glassivée.
- IGT défini dans les quatre quadrants.

AVANTAGES :

- Excellente tenue aux $(dv/dt)_C > 10 \text{ V}/\mu\text{s}$.
- L'encapsulation métallique confère une excellente impédance thermique assurant une bonne fiabilité.

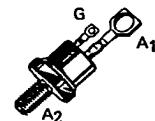
APPLICATIONS :

- Commande de moteur.
- Régulation de chauffage.
- Variateur de lumière.

$I_{TRMS} = 25 \text{ A}/T_C = 60^\circ\text{C}$

$V_{DRM} : 200 \text{ V} \rightarrow 1200 \text{ V}$

Case Boîtier : TO 48 metal (CB-267)



Standard type : 1/4"-28 UNF

On request, type number + suffix M : ISO M6

ABSOLUTE RATINGS (LIMITING VALUES) VALEURS LIMITES ABSOLUES D'UTILISATION

	Symbols	TRAL 1125 D → TRAL 1225 D	Units
RMS on-state current (360° conduction angle) <i>Courant efficace à l'état passant (angle de conduction 360°)</i>	$T_C = 60^\circ\text{C}$	I_{TRMS}	A
Non repetitive surge peak on-state current (on full cycle) at $25^\circ\text{C} < T_j \text{ initial} < 100^\circ\text{C}$ <i>Courant non répétitif de surcharge crête accidentelle à l'état passant (1 cycle complet) à $25^\circ\text{C} < T_j \text{ initial} < 100^\circ\text{C}$</i>	$F = 60 \text{ Hz}$ $F = 50 \text{ Hz}$	I_{TSM}	A
I^2t value <i>Valeur de la constante I^2t</i>	$t = 10 \text{ ms}$	I^2t	A^2s
Critical rate of rise of on-state current <i>Vitesse critique de croissance du courant à l'état passant</i>	Repetitive $F = 60 \text{ Hz}$ Non Repetitive	di/dt	$\text{A}/\mu\text{s}$
Storage and operating junction temperature range <i>Températures extrêmes de stockage et de jonction en fonctionnement</i>	T_{STG} T_j	$-40 \rightarrow +150$ $-40 \rightarrow +100$	$^\circ\text{C}$

ABSOLUTE RATING (LIMITING VALUE) VALEUR LIMITÉE ABSOLUE D'UTILISATION

Symbol	TRAL 1125 D	TRAL 2225 D	TRAL 3325 D	TRAL 3825 D	TRAL 1025 D	TRAL 1225 D	Unit
V_{DRM}	± 200	± 400	± 600	± 700	± 1000	± 1200	V

*Gate supply
Générateur de gâchette : $20 \text{ V}/20 \Omega - t_r < 0,1 \mu\text{s}$ -

Half sine wave $6,3 \mu\text{s}$
Demi-sinusoidé de $6,3 \mu\text{s}$

$-V_{DRM}$ specified
spécifiée

October 1984 - 1/4

Thermal resistance Résistance thermique	Symbols	TRAL 1125 D → TRAL 1225 D	Units
Contact (case-heatsink) for recommended stud torque Contact (boîtier-radiateur) au couple de serrage recommandé	R _{th} c-h	0,4	°C/W
Junction to case for DC Jonction - boîtier en continu	R _{th} j-c DC	1,24	°C/W
Junction to case for 360° conduction angle (F = 50 Hz) Jonction - boîtier pour angle de conduction 360° (F = 50 Hz)	R _{th} j-c AC	0,93	°C/W

GATE CHARACTERISTICS (MAXIMUM VALUES)**CARACTÉRISTIQUES DE GACHETTE (VALEURS MAXIMALES)**

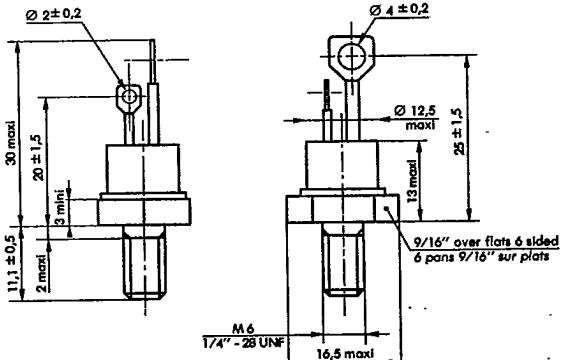
$$P_{GM}^* = 40 \text{ W } (t = 10 \mu\text{s}) \quad P_{G(AV)} = 1 \text{ W} \quad I_{GM}^* = 6 \text{ A } (t = 10 \mu\text{s}) \quad V_{GM}^* = 16 \text{ V } (t = 10 \mu\text{s})$$

ELECTRICAL CHARACTERISTICS ($T_J = 25^\circ\text{C}$ unless otherwise specified)**CARACTÉRISTIQUES ÉLECTRIQUES ($T_J = 25^\circ\text{C}$ sauf spécification contraire)**

Symbols	Quadrants	Values			Units	Test conditions
		min.	typ.	max.		
I _{GT}	I-II-III			100	mA	V _D = 12 V R _L = 33 Ω Pulse duration > 20 μs
	IV			150		V _D = 12 V R _L = 33 Ω Pulse duration > 20 μs
V _{GT} *				3	V	V _D = 12 V R _L = 33 Ω Pulse duration > 20 μs
V _{GD} *		0,2			V	T _J = 100°C V _D = V _{DRM} R _L = 3 kΩ Pulse duration > 20 μs
I _H **				50	mA	V _D = 12 V Gate open
I _L	I-III-IV		50		mA	V _D = 12 V R _L = 33 Ω Pulse duration > 20 μs
	II		100			V _D = 12 V R _L = 33 Ω Pulse duration > 20 μs
V _{TM} **				2	V	I _{TM} = 35 A t _p = 10 ms
I _{DRM} **				3		T _J = 100°C V _{DRM} rated Gate open
dV/dt**		100			V/μs	T _J = 100°C Gate open Linear slope up to 0,67 V _{DRM}
(dV/dt) _C **		10			V/μs	T _C = 60°C (dI/dt) _C = 11,2 A/ms I _{TRMS} and V _{DRM} rated
t _{gt} *			3		μs	dI/dt = 2 A/μs I _G = 200 mA I _{TRMS} and V _{DRM} rated

* For either polarity of gate voltage with reference to electrode A₁.

** For either polarity of electrode A₂ voltage with reference to electrode A₁.

CASE DESCRIPTION
DESCRIPTION DU BOÎTIER

Cooling method : by conduction (method C)

Marking : type number

Weight : 13,5 ± 1g

Stud torque : 3,5 mNm min - 3,8 mNm max

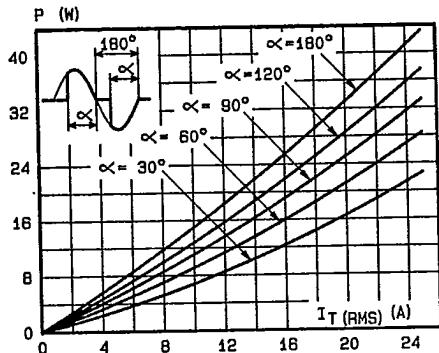


Fig.1 - Maximum mean power dissipation versus RMS on-state current.

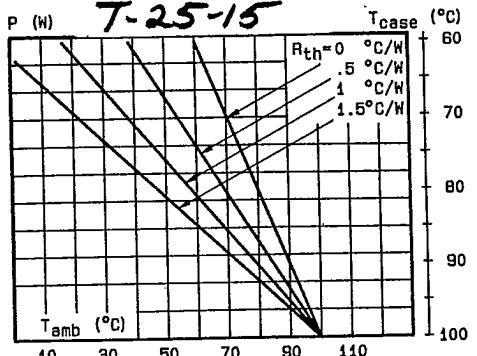


Fig.2 - Correlation between maximum mean power dissipation and maximum allowable temperatures (T_{amb} and T_{case}) for different thermal resistances heatsink + contact.

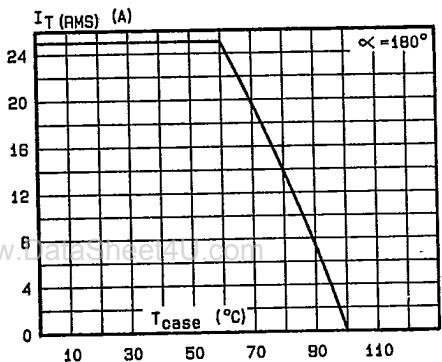


Fig.3 - RMS on-state current versus case temperature.

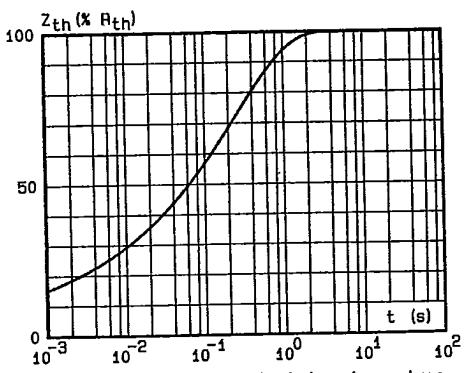


Fig.4 - Thermal transient impedance junction to case versus pulse duration.

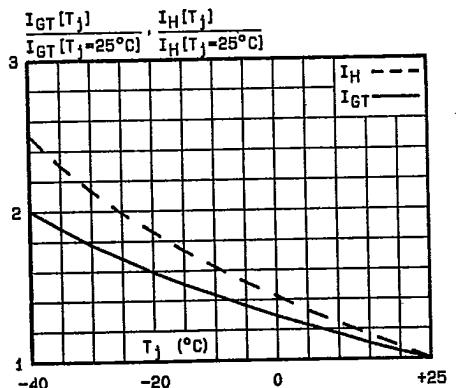


Fig.5 - Relative variation of gate trigger current and holding current versus junction temperature.

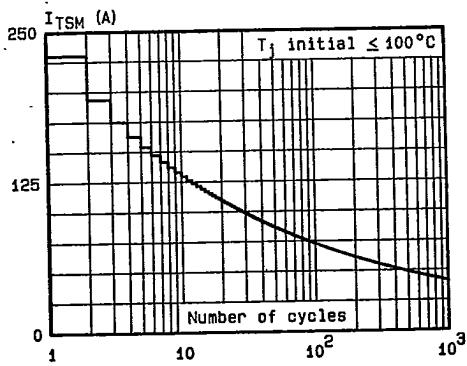


Fig.6 - Non repetitive surge peak on-state current versus number of cycles.

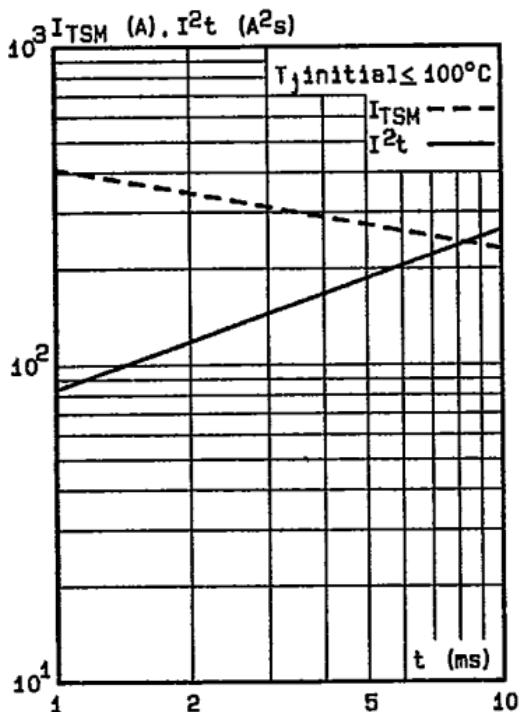


Fig.7 - Non repetitive surge peak on-state current for a sinusoidal pulse with width: $t \leq 10\text{ms}$, and corresponding value of $I^2 t$.

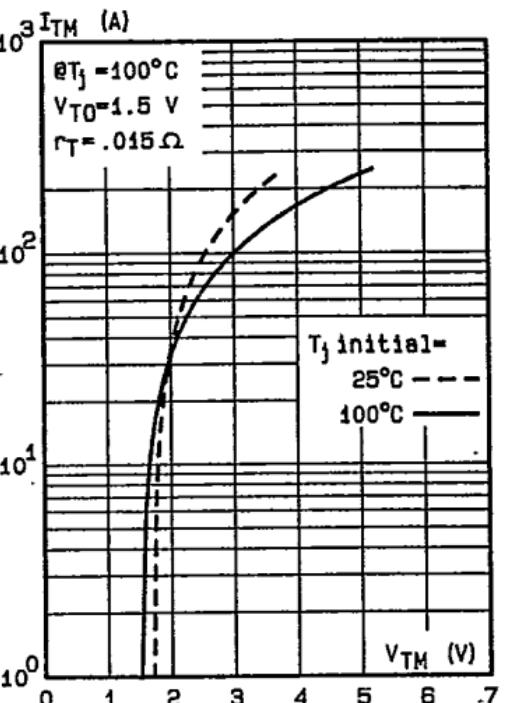


Fig.8 - On-state characteristic (maximum values).